# Ambipolar charge carrier transport in organic semiconductor blends of phthalocyanine and fullerene

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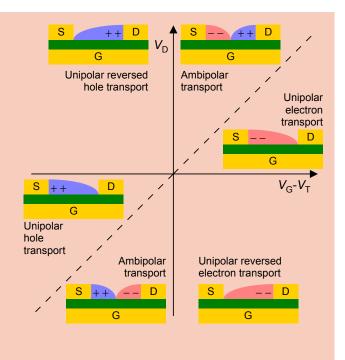
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Ambipolar charge carrier transport is realised in organic field-effect transistors using mixtures of p-conductive copperphthalocyanine and n-conductive buckminster fullerene as active layer. These blends are model systems for ambipolar transport with adjustable field-effect mobilities for electrons and holes by variation of the mixing ratio. Thereby balanced mobilities for both charge-carrier types are possible.

In this paper we discuss the variation of mobility, threshold voltage and electronic energy levels with the mixing ratio. The charge carrier mobilities are strongly reduced upon dilution of the respective conducting phase by the other species. This shows that transport of each carrier species occurs by percolation through the respective phase in the blend. A strong correlation between contact resistance and mobility indicates that carrier injection is diffusion limited. A charge redistribution in the copper-phthalocyanine causes a hole accumulation at the organic/organic interface and affects thereby the threshold voltage for holes. By analysing the electronic structure using photoelectron spectroscopy no charge transfer was found in the ground state. The common work function of these blends changes linearly between the work functions of the neat materials. Thus a constant ionisation potential for the highest occupied molecular orbitals of the two materials is obtained.

Furthermore we have fabricated ambipolar inverters using mixed organic semiconductor layers and compare their behaviour to complementary inverters consisting of discrete pand n-channel transistors. The experimental findings and concomitant simulations demonstrate the need for balanced electron and hole mobilities in order to achieve symmetric inverter characteristics. However, they also reveal the superior performance of true complementary logic inverters towards their ambipolar pendants.



Sketch for the unipolar and ambipolar operation regimes of an organic field-effect transistor.  $V_{\rm D}$  denotes the drain voltage,  $V_{\rm G}$  and  $V_{\rm T}$  are gate and threshold voltage, respectively.

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**1 Introduction** Organic semiconductors have attracted considerable interest due to their growing potential as active materials in electronic and optoelectronic devices. A long-standing paradigm, however, has been their unipolar transport of electrical charges. This means that, apart from very few exceptions, until recently organic semiconductors have shown electrical conduction for one carrier species only, with positive carriers being preferentially transported in most materials. Nevertheless, both electron and hole transport were observed many years before in organic single crystals with photo generated charge carriers [1]. Thereby almost equal electron and hole mobilities with a temperature dependence indicative for band transport were obtained. This indicates that there is a priori no intrinsic asymmetry between the transport of electrons and holes in the bulk of high-purity organic semiconductors.

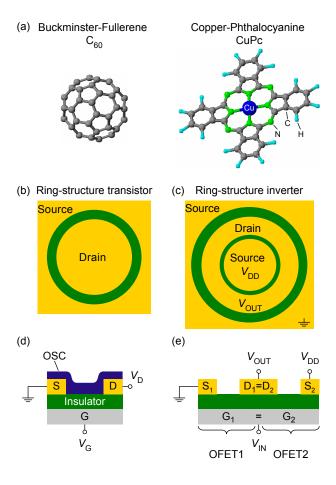
In organic field-effect transistors (OFETs) the transport of carriers is limited in addition to the intrinsic material properties by the injection from the electrodes and by traps at the organic/insulator interface. Thus for many years, OFETs were reported to show either p- or n-type behaviour (see, e.g., Ref. [2] for an overview of materials). Ambipolar transport in OFETs was observed for the first time by Meijer et al. using mixtures of a soluble poly(phenylen vinylene) derivative (MDMO-PPV) and a fullerene derivative (PCBM) [3], which are known from bulk-heterojunction solar cells [4]. The phenomenon of ambipolar transport itself was reported already in the 1970s in the context of hydrogenated amorphous silicon thin film transistors [5]. Meanwhile ambipolar OFETs, where two different materials for electron and hole transport are used, have been realized with a variety of material combinations, including polymer/fullerene blends [3], mixtures of soluble oligomers [6] as well as evaporated molecular hetero-layer structures and mixed layers [7-11]. However, even in neat films of a single organic semiconductor ambipolar transport can be observed provided that the barrier for electron injection is reduced by choosing low-work function metals as source/drain electrodes. It has been demonstrated, e.g., that electron transport can be obtained in pentacene when Ca is used as electrode material [12,13]. Another possibility to get electron transport in traditionally p-conducting materials is to suppress electron trapping at the interface to the gate-dielectric by surface functionalization or suitable polymeric dielectrics. E.g., if silicon oxide is used as insulator, the surface usually contains hydroxyl groups acting as electron traps. It has been shown that terminating these OH-groups by silanisation [14] or interface doping by calcium [15] are suitable tools to achieve ambipolar transport in a large variety of materials. Recently, also low-band gap materials have been suggested as further candidates for ambipolar OFETs [16, 17]. Due to their small energy gap (sometimes below 1 eV) and suitable molecular energy levels (ionisation energy and electron affinity) the injection of both carrier species is easily obtained with a single metal for source and drain electrodes.

In this work we have chosen the combination of hole-conducting copper-phthalocyanine (CuPc) and the n-conducting fullerene  $C_{60}$ , which are both known from organic photovoltaic cells either as heterolayer structures or bulk-heterojunctions [18–21]. They can be considered as model systems for ambipolar transport where the asymmetry of the electron and hole mobilities is adjustable by the concentration of both materials in the mixture.

The figure in the abstract shows a sketch of the ambipolar operation of an FET and the respective charge carrier distribution. The unipolar regime with  $|V_{\rm D}| < |V_{\rm G} - V_{\rm T}|$ is dominated by the transport of only one charge carrier species — either electrons or holes, depending on the material and the electrodes. In the ambipolar regime both electrons and holes are injected into the semiconductor. This occurs in the regime where in the transfer characteristics (constant drain voltage) the unipolar FET is normally in the OFF state. Furthermore, for opposite sign of  $V_{\rm D}$  and  $V_{\rm G}$ - $V_{\rm T}$  even reversed unipolar transport can be observed in this case. The charge carrier distribution shows the decrease of charge carrier concentration inside the channel [22] and indicates the location where electrons and holes recombine. The position of this recombination zone depends on the applied voltages and can be shifted inside the channel as observed in ambipolar light-emitting FETs [23–25].

2 Materials, device preparation and experimental **methods** Copper-phthalocyanine (CuPc, purchased from Aldrich as sublimation grade) and buckminster fullerene (C<sub>60</sub>, purchased from Hoechst as super gold grade) were used as hole and electron conducting materials, respectively. The structural formulas are given in fig. 1a. The materials were deposited by thermal evaporation from lowtemperature effusion cells in a vacuum better than  $1 \times 10^{-7}$  mbar to form neat and mixed layers with a thickness of about 25 nm on prestructured substrates to realise a bottom-gate and bottom contact geometry (see fig. 1d). The deposition rates were between 0.35 Å/s for neat films and 1.4 Å/s for layers with 1:3 stoichiometry. The given mixing ratios in this paper are volume percentages as the evaporation process was controlled via two independent deposition monitors using quartz microbalances. They are always given in the form C<sub>60</sub>:CuPc. Additionally, different substrate temperatures (300 and 375 K) were used during evaporation of the materials.

Organic field-effect transistors were fabricated on highly conductive Si wafers (1-5 m $\Omega$ ·cm) with a 200 nm or 320 nm thick thermally grown oxide, which acts as gate insulator. Photolithographically patterned Au (100 nm, using 1 nm Ti as adhesion layer) source and drain electrodes were made by electron-beam evaporation and by lift-off process. These structures were cleaned in an ultrasonic bath with solvents (acetone, isopropyl) and ultra-pure water. The substrates were dried with pure nitrogen, treated with an O2-plasma for 60 s at 200 W and 0.6 mbar, and heated in forevacuum at 400 K for 2 hours. On some of the samples ad-



**Figure 1** (a) Chemical structures of the used materials: fullerene  $(C_{60})$  and copper-phthalocyanine (CuPc). Top view (b) and cross section (d) of the ring-type transistor in bottom-gate and bottom-contact geometry. Top view (c) and cross section (d) of the ring-type inverter. The silicon substrate acts as the gate electrode for transistors and inverters.

ditionally a treatment of the silicon oxide surface by octadecyltrichlorosilane (OTS) was made before they were heated [26]. This OTS treatment was carried out at room temperature, in a solution of OTS in n-heptane (0.86mM), in an exsiccator. Subsequently the samples were cleaned from residual OTS in chloroform in an ultrasonic bath.

Transistors with a ring-type geometry (see fig. 1b) were used, whose source electrodes form a closed ring around the drain electrodes. This prevents parasitic currents from outside of the active transistor channel without the necessity of structuring the organic semiconductor [28]. The channel length and width were 5  $\mu$ m and 2500  $\mu$ m, respectively. Ambipolar inverters were made from two transistors stacked into each other (see fig. 1c and have an additional ring channel around the first one. Thus both transistors share the common silicon substrate gate electrode as input of the inverter and the drain electrode as output (see fig. 1e). Length and width of the outer channel were

 $10~\mu m$  and  $2500~\mu m$ , respectively, and of the inner channel 8  $\mu m$  and  $2000~\mu m$ , respectively. Consequently the ratio of length to width was the same for both channels. Each substrate ( $20~mm\times20~mm$ ) contained 24 individual transistors and 12 inverter structures to allow for a comparison of several devices. Complementary inverters were fabricated by evaporating neat CuPc and  $C_{60}$  each on one half of a prestructured substrate. For this purpose two evaporation steps were necessary with different shadow masks. In this case two separated transistors, one p-type and one n-type, from different areas on the substrate were connected together to form an inverter.

Without air-exposure the devices were transferred to a vacuum-chamber providing a pressure less than  $5\times10^{-6}$  mbar for characterization. The output and transfer characteristics of the transistors were measured using two independent source-meter units (Keithley 236). In order to measure inverter transfer curves an additional source-meter unit (Keithley 2400) was implemented.

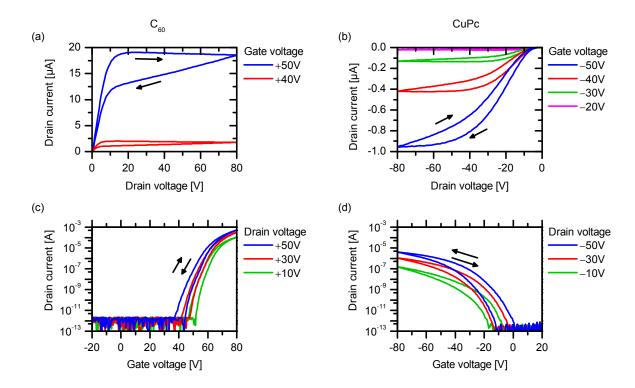
The charge-carrier mobilities  $\mu$  and the threshold voltages  $V_{\rm T}$  were extracted from the slope of the transfer characteristics in the saturation region  $|V_{\rm D}|>|V_{\rm G}-V_{\rm T}|$  using the standard relationship:

$$I_{\mathrm{D,sat}} = \frac{W}{2L} \cdot \mu \cdot C_{\mathrm{Ox}} \left( V_{\mathrm{G}} - V_{\mathrm{T}} \right)^{2}. \tag{1}$$

Here W is the channel width, L is the channel length,  $C_{\rm Ox}$  is the gate-oxide capacitance per unit area,  $V_{\rm G}$  is the gate voltage, and additionally  $V_{\rm D}$  is the drain voltage. Mobility  $\mu$  and threshold voltage  $V_{\rm T}$  were determined from the linear regression of the measured data plotted as  $\sqrt{I_{\rm D,sat}}$  vs.  $V_{\rm G}$ . The inverter characteristics include the transfer curve  $V_{\rm OUT}$  vs.  $V_{\rm IN}$  as well as the current dissipation  $I_{\rm DD}$  vs.  $V_{\rm IN}$ .

X-ray diffraction (XRD) patterns were obtained in  $\theta$ -2 $\theta$  geometry using a Siemens D-500 diffractometer (Cu K $_{\alpha}$  radiation with a wavelength of 0.1542 nm) for analyzing the crystallinity of the films. The morphology investigations were performed using a Thermo Microscopes Auto Probe scanning force microscope (SFM) operated in noncontact (tapping) mode.

For photoelectron spectroscopy organic layers (neat films and mixtures) with a nominal thickness of 25 nm were deposited on 100 nm thick gold films which were thermally evaporated onto oxidized Si wafers. The electronic properties of the films were characterized using X-ray and ultraviolet photoelectron spectroscopy (XPS, UPS) by employing monochromated Al K $\alpha$  radiation ( $h\nu$ =1486.7 eV) for measurement of the core levels as well as ultraviolet radiation [He I ( $h\nu$ =21.2 eV) and He II ( $h\nu$ =40.8 eV)] for an analysis of the occupied states near the Fermi level. For a measurement of the secondary electron cut-off to exactly determine the sample work function, an additional bias (-2 V and -5 V) was applied to the sample.



**Figure 2** Output and transfer characteristics of unipolar field-effect transistors with neat  $C_{60}$  (a, c) and neat CuPc (b, d) films. The substrates were treated with  $O_2$ -plasma and the films evaporated at 375 K substrate temperature. The direction of the hysteresis is indicated by arrows. (Figure adopted from Ref. [27])

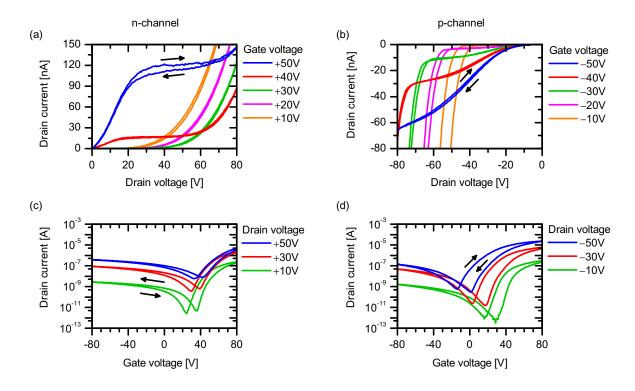
**3 Unipolar field-effect transistors** Output and transfer characteristics of neat  $C_{60}$  and CuPc FETs are shown in fig. 2. The output characteristics show the typical unipolar transistor behavior with linear increase at low drain voltage and saturation at higher  $V_D$ . The transfer characteristics display an off-regime followed by an increase of drain current with increasing absolute value of the gate voltage exceeding the switch-on voltage.

The analysis of the shown transfer characteristics yielded saturation mobilities for these preparation conditions ( $O_2$  plasma treatment, 375 K during evaporation) of  $7\times10^{-2}$  cm<sup>2</sup>/Vs for the  $C_{60}$  FET and  $6\times10^{-4}$  cm<sup>2</sup>/Vs for the CuPc FET. The threshold voltages were +63 V and -31 V, respectively.

The measured I-V characteristics show considerable hysteresis between increasing and decreasing voltage sweeps which can be attributed to dynamic processes in the charging of the semiconductor-dielectric interface [29], originating e.g. from polaron-bipolaron reactions [30] or trap recharging [31], but in this paper will not be discussed furthermore. The largest hysteresis is present in the output characteristics of the  $C_{60}$  FET. The hysteresis in all other measurements, including the ambipolar FETs, and in particular for the transfer characteristics which were used for the analysis, are significantly smaller.

The curvature in the output characteristics of CuPc at the origin of the I-V diagram suggests a considerable injection barrier of the contact [32], whereas the linear increase in the  $C_{60}$  FET indicates a significantly smaller one. As we will show later on (see section 8), this can be related to the electronic structure of the Au/CuPc and the Au/ $C_{60}$  interface, respectively [33–38]. However, it should be noted that other possibilities such as an influence of the adhesion layer [39], or from traps in the semiconductor [40] or from a field-dependent charge carrier mobility [41] have been put forward to account for nonlinearities in the T-V characteristics

4 Ambipolar field-effect transistors Ambipolar FETs with mixing ratios of 1:3, 1:1 and 3:1 between  $C_{60}$  and CuPc have been investigated. All of them showed ambipolar transport with the same qualitative features as the 1:1 mixture displayed in fig. 3. Here a strong increase of the current in saturation of the output characteristic (fig. 3a, b) is measured for both the n- and the p-channel regime. This is a clear signature of ambipolar behavior. Electrons are injected at higher drain voltages into the hole-conducting channel, and vice versa. Consequently, the transfer characteristics (fig. 3c, d) do not show any off regime as the ambipolar increase takes place in the regime where the FET with the neat materials is switched off.



**Figure 3** Output and transfer characteristics of ambipolar field-effect transistors for a mixing ratio between  $C_{60}$  and CuPc of 1:1 measured in the n-channel regime (a, c) as well as the p-channel regime (b, d). The substrate was  $O_2$ -plasma treated and the film evaporated at 375 K substrate temperature. The direction of the hysteresis is indicated by arrows. (Figure adopted from Ref. [27].)

The magnitude of the drain currents in both regimes differs significantly for this mixing ratio. The p-channel (negative  $V_{\rm G}$ ) shows a current which is three orders of magnitude lower than the current in the n-channel (positive  $V_{\rm G}$ ). In both measurements the curvature in the output characteristics at the origin of the I-V diagram suggests injection barriers with non-linear contact resistances. Here this contact resistance is also visible in the electron channel and even more pronounced in the hole channel because the conductivity of both channels is reduced due to mutual dilution of the conducting material by the other species.

# 5 Charge carrier mobility and threshold voltage

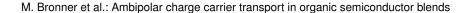
For the analysis of the mobility and the threshold voltage the saturation regime is used here. An analytical model based on the Shockley equation by Schmechel et al. [13] assumes that the electron and hole mobilities as determined from the linear or saturation regime are also valid in the ambipolar regime. As previously shown for the system under consideration the mobilities determined from the saturation and ambipolar regime are in excellent agreement [27].

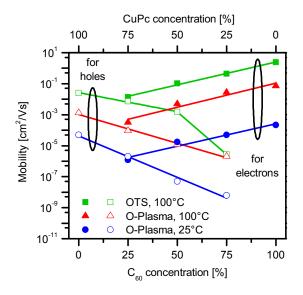
Figure 4 shows the mobility and the threshold voltage determined from the saturation regime as a function of concentration in the blend for different preparation conditions. We note that these data have been obtained by averaging

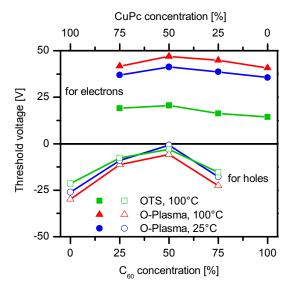
over several identically prepared samples. The substrate temperature during evaporation of the blends was  $25^{\circ}$ C and  $100^{\circ}$ C for the O-plasma treated silicon oxide surface. The surface chemistry was modified additionally for the  $100^{\circ}$ C substrate temperature by silanisation of  $SiO_2$  with OTS.

In all cases, an exponential decrease of both electron and hole mobility is observed upon dilution of the corresponding conducting material with the other species. Remarkably, all blends with different mixing ratios show charge carrier transport for both charge carrier types. This means that there is always a percolation path for both electrons and holes. However, the hopping distance between molecules of the same type is increased upon mixing with the other species thus leading to a decreasing wave-function overlap. This is well-established for molecularly doped polymers [42], where a homogenous dilution of conducting molecules in an inert matrix is present. This scenario might even hold for nano-phase separated granular films, for which we have indications from SFM data (see below). In this case the mobility limiting step would be the hopping between grains where the average distance should also increase upon dilution.

As compared to film growth at room temperature, an increased mobility is found for the higher substrate temperature and a further increase is realised by lowering the surface energy with OTS. This increase of mobility was re-







**Figure 4** Mobility (left) and threshold voltage (right) as determined from transfer characteristics in the saturation regime of OFETs with different composition, substrate temperature and substrate treatment. The filled symbols are related to the electron transport, the open symbols to the hole transport.

ported for unipolar OFETs [43] and is also valid for these blends. Interestingly, for all treatments balanced mobilities are found at about 25% C<sub>60</sub> content.

At this point it is noteworthy to compare our results on the variation of charge carrier mobilities with composition of the blends to other ambipolar mixed systems. There are on the one hand polymer-fullerene blends used for photovoltaic applications (in particular MDMO-PPV:PCBM) [44,45] and on the other hand blends of molecular materials implemented again in photovoltaic devices (mostly phthalocyanine:C<sub>60</sub>) [46] and ambipolar light-emitting transistors [47]. In both types of blend systems one observes as a common feature a strong (in many cases exponential) decrease of the mobility of one carrier type with increasing dilution by the other component. (A remarkable exception from this rule is the hole mobility in polymer-fullerene blends in which the addition of fullerene molecules even improves  $\mu_h$ . In this case a stretching of the polymer chains occurs leading to improved interchain hopping [45].)

It is remarkable, however, that despite of a roughness which is larger than the film thickness in some of our films (see below), all of them show n-channel as well as p-channel transport. Obviously, there still exists a percolation path for conduction in both materials independent of phase separation and order formation. We also note that the bulk morphology does not necessarily provide precise information for organic field-effect transistors since in these devices the active channel is restricted to the first few molecular layers at the interface to the gate dielectric [48–50].

The threshold voltage shows a dependence on the mixing ratio for the hole channel, but not for the electron channel. By contrast, the threshold voltage for the electron channel changes with the preparation conditions, especially with the OTS passivation of the silicon oxide. The reason is that the O-plasma treated oxide surface contains OH-groups which are acting as electron traps and increase the threshold voltage for electrons [14]. By surface treatment with OTS these traps are at least partially passivated and the threshold voltage decreases. The change of threshold voltage for the hole transport with the concentration is related to the organic/organic interface in the CuPc/C<sub>60</sub> blend [27] and can be explained by a hole accumulation at the CuPc side of the C<sub>60</sub>/CuPc interface [36]. Because there is no charge transfer from CuPc to C<sub>60</sub> in the ground state this shift should be related to a redistribution of charges within the CuPc molecules in the presence of  $C_{60}$  as demonstrated by calculations [51]. As expected, this charge displacement is independent on the preparation conditions. The threshold voltage shift is related to an interface charge [32] at the organic/organic interface in the proximity of the insulator by:

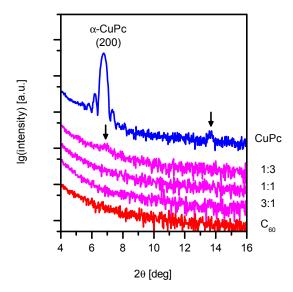
$$\Delta V_{\rm T} = \frac{e \cdot N_{\rm If}}{C_{\rm Ox}}.$$
 (2)

By modeling the molecular packing [27] a charge accumulation of about 0.012 charges per molecule is estimated. The calculated charge transfer in an ideal complex of one  $C_{60}$  and one CuPc molecule was calculated to be

0.06 charge per molecule [51], 5 times higher than determined here.

6 Film morphology and structure In order to get more insight into the concentration dependent electron and hole mobility, structure and morphology of neat and mixed films (evaporated at 375 K) were investigated by x-ray diffraction and scanning force microscopy. XRD measurements (fig. 5) show a strong (200) peak corresponding to the  $\alpha$ -phase for the neat CuPc film and a weak (200) peak for the film with a 1:3 mixture, whereas for all other mixtures including neat C<sub>60</sub> films no diffraction peaks are detectable, indicating a structure without coherent diffraction, e.g. amorphous or very small crystallites. These observations are in full agreement with measurements reported on CuPc:C<sub>60</sub> mixtures for photovoltaic applications by Rand et al. [46]. The authors observed a disappearance of the CuPc diffraction peak for a fullerene content of more than about 15% and asserted no peak corresponding to  $C_{60}$ , although, like in our case, the electron mobility in neat  $C_{60}$ films was about two orders of magnitude higher than the hole mobility in CuPc. Other groups have obtained crystalline C<sub>60</sub> films, however, only at elevated substrate temperatures of about 440 K during evaporation [52].

Figure 6 shows the surface morphologies for different mixing ratios as investigated by non-contact SFM for small areas. Neat CuPc films have a needle-like structure, corresponding to the  $\alpha$ -phase structure observed in XRD. This



**Figure 5** X-ray diffraction patterns for neat CuPc and  $C_{60}$  films as well as for three mixed films grown at 375 K. The arrows are indicating the weak (200) peak in the sample with a mixing ratio of 1:3 and the second order diffraction peak of the neat CuPc sample.

film shows a low root mean square roughness (RMS) of only 2.2 nm. Also the Laue oscillations beside the diffraction peak for the neat CuPc film (see fig 5) are an indication for a well defined film thickness. For neat  $C_{60}$  films a rough and granular structure is observed. Compared to the CuPc film, the roughness of the films is increasing with increasing  $C_{60}$  content.

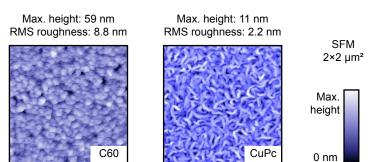
We note that we have also investigated films deposited without substrate heating by XRD and SFM (not shown here). These films are much smoother (RMS roughness of only 2.3 nm in all cases) and do not have such large grains. In particular, the neat CuPc film does not show a needle-like morphology in agreement with work by Schultes et al. [54]. However, in contrast, to this work there is no indication for an  $\alpha$  to  $\beta$  conversion for our CuPc film grown at elevated temperature. For both preparation conditions the XRD data indicate the presence of the  $\alpha$ -phase.

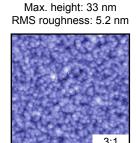
The film roughness has also been studied by XPS measurements of neat films and blends deposited on Au covered Si wafers (for details see next section). In this technique the intensity ratio  $I_{\rm Au4f}/I_{\rm C1s}$  of the Au4f and the C1s core level peaks can be used as a measure of the homogeneity in the film thickness. As shown in fig. 7 the Au substrate signal is zero for a closed and flat CuPc film and increases with increasing  $C_{60}$  content indicating film roughening. Here it is important to remember that measurements using SFM are a very local probe whereas XPS measurements sample a much larger area. Nevertheless both techniques show a similar trend for the roughness of the blended films.

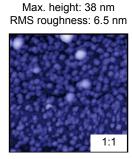
Furthermore phase separation of  $C_{60}$  and CuPc is described at elevated temperatures [55] which affects the molecular arrangement, but can not be detected by the techniques used here. Altogether, film morphology and structure of blends of flat CuPc and spheric  $C_{60}$  molecules are still not very well understood and need further investigation. This will become particularly important in photovoltaic cells, where this material combination is a potentially promising candidate for so-called bulk-heterojunction cells [21,56].

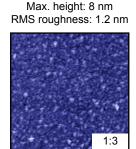
**7 Electronic structure** For analysing the electronic structure the neat and mixed organic films were deposited on gold films which were pretreated in an oxygen plasma prior to the deposition of the organic materials. This treatment was chosen instead of in-situ preparation of the gold layer under high-vacuum conditions to realise the same electrode properties as in OFETs. It should be noted that transporting the gold films through ambient air after the oxygen plasma treatment leads to the formation of a conductive hydrocarbon layer [57]. The work function of gold covered by this hydrocarbon layer is determined by photoelectron spectroscopy (PES) to be 4.2 eV, whereas a clean gold substrate (after removal of the adsorbed species by Ar<sup>+</sup> ion bombardment) exhibits a work function of 5.4 eV.

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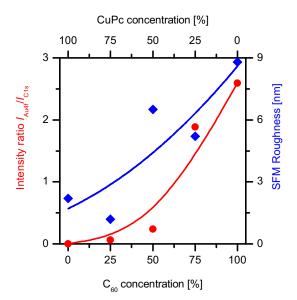








**Figure 6** Scanning force microscopy images taken in noncontact mode for neat  $C_{60}$  and CuPc films as well as for three mixed films grown at 375 K. The total image size is  $2 \times 2 \, \mu \text{m}^2$ . The max. height is given as the difference between the lowest value (dark blue) and the highest value (white) in each of the images.



**Figure 7** Comparison of the RMS roughness measured by SFM and the ratio of the substrate to film signal measured by XPS. The solid lines are to guide the eyes.

Figure 8 shows the important results of the XPS and UPS measurements. The CuPc C1s spectrum contains the C-C bond ( $E_{\rm B}$ =284.2 eV, indicated by small ticks) and the chemically shifted C-N ( $E_{\rm B}$ =285.6 eV) bond, as well as their  $\pi$ - $\pi$ \* satellites. For C<sub>60</sub> only one pronounced feature is visible at  $E_{\rm B}$ =284.7 eV. Both spectra are in agreement with published results on pristine materials [33,58]. The

composition of the blends and the CuPc and  $C_{60}$  related C1s peak positions are determined by fitting the spectra of the mixed films with Gauss-Lorentz-functions using the shape of the neat  $C_{60}$  and CuPc core levels. As shown in fig. 8a the energetic positions of the C1s features are slightly shifting upon addition of  $C_{60}$ . The N1s spectra (not shown) were also analysed for the peak position and found to behave in a similar manner.

The electronic structure of the occupied states near the Fermi level (measured using He II radiation) is shown in fig. 8b. The maxima of the HOMO levels of the neat materials are indicated by small ticks. Whereas the CuPc HOMO level is clearly separated for all mixed films, the HOMO level of  $C_{60}$  is only visible in films with a concentration of 77% and 100%. For smaller amounts of  $C_{60}$  in the films the HOMO level is present only as a shoulder in the occupied molecular orbitals of CuPc. Again, the spectra can be described as a linear superposition of neat material spectra if a shift of the energetic position is included.

The work function of the films was determined from the secondary electron cut-off in the He I spectra with applied bias (see fig. 8c). As for the core and the HOMO levels an energy shift of the secondary electron cut-off with the film composition is present.

The graph in fig. 9 shows a comparison of the obtained vacuum levels of the organic films and the substrate  $(E_{\rm Vac}^{\rm Org}$  and  $E_{\rm Vac}^{\rm Sub})$ , of the HOMO levels  $(E_{\rm HOMO}^{\rm Org})$  (defined as the HOMO edge near the Fermi level), as well as of the C1s and N1s core levels  $(E_{\rm C1s}^{\rm Org}$  and  $E_{\rm N1s}^{\rm Org})$  depending on the mixing ratio. The ionization energy of the neat films is 6.2 eV for  $C_{60}$  and 5.0 eV for CuPc in agreement with the literature [36] and the difference of the work function amounts to about  $\sim 0.5$  eV.

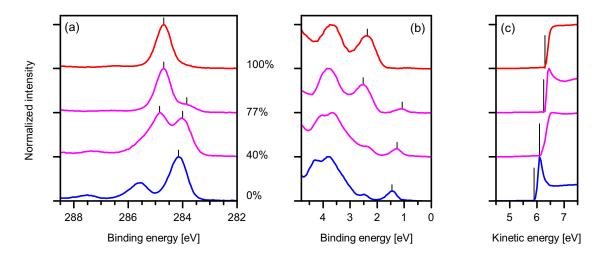


Figure 8 XPS and UPS measurements of neat and different mixed films of  $C_{60}$  and CuPc: (a) C1s spectra (excitation: monochromated Al K $\alpha$ ), (b) HOMO levels (excitation: He II) and (c) secondary electron cut-off (excitation: He I and  $V_{\rm Bias}$ =-2 V). The numbers on the right side of the diagram (a) give the  $C_{60}$  concentration as determined from the measurements shown in part (a). (Figure adopted from Ref. [53].)

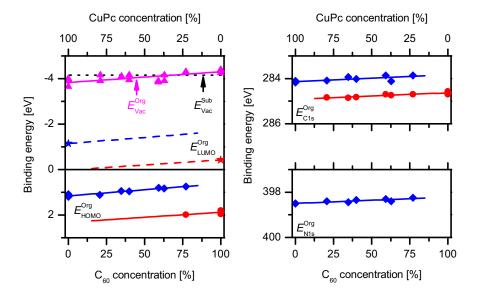


Figure 9 Position of the vacuum level, the high energy edge of the HOMO level, and the C1s and N1s core levels as a function of the  $C_{60}$ /CuPc mixing ratio. The  $\blacklozenge$  and the • symbols are representing the measured values for C<sub>60</sub> and CuPc related levels, respectively, and the ▲ symbols the measured work functions. The solid lines are linear fits of the corresponding measured values. The constant dotted line is the vacuum energy of the gold substrate (covered by a conductive hydrocarbon layer). The LUMO levels of the neat materials are marked with the \* symbols. The dashed lines are extrapolated LUMO levels for the blends. (Figure adopted from Ref. [53].)

It is remarkable that the secondary electron cut-offs used to determine the work function of all mixtures were sharp and did not show a double step that would reflect two different local surface potentials [59], although the films have a nanogranular morphology as determined by atomic force microscopy [27]. Thus, the blends show a common vacuum level which shifts linearly with the concentration between the work functions of the neat materials given by  $\Phi_{\rm CuPc}$ =3.8 eV and  $\Phi_{\rm C_{60}}$ =4.3 eV. The linear change of the work function in our studies suggests that CuPc/C<sub>60</sub> mix-

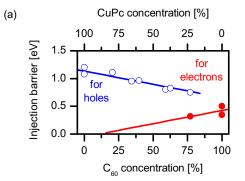
tures are electronically non-interacting (unless they are optically excited).

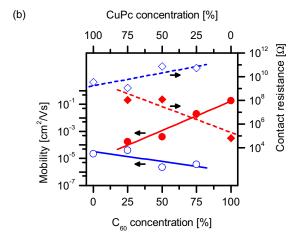
Taken all results together, there is no evidence for a ground state charge transfer in blends of CuPc and  $C_{60}$ . The core level spectra can be described solely with the scaled features of the neat materials. Also the occupied molecular orbitals do not show additional structures unknown from the neat materials [51,36]. The analysis of the difference between the occupied levels (core and HOMO levels) and the vacuum level shows for all compositions a

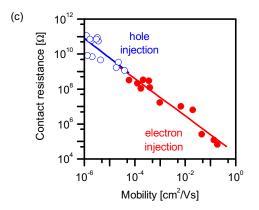
constant ionization energy. This is manifested in identical shifts of the core levels, the HOMO levels and the vacuum level with the concentration of the blends. Thus the molecular levels are simply following the change of the common vacuum energy.

Figure 9 allows to draw some important conclusions for charge carrier injection in organic semiconductor blends. For this purpose one also needs information on the lowest unoccupied molecular orbitals (LUMO) of the films. Unfortunately, by now there are no direct measurements of the LUMO level for blends but only for the neat materials [37, 38]. However, one can take these data obtained from inverse photoemission and extrapolate them towards blends using the same shift of the LUMO levels that was observed for all other levels. In other words, we assume that the energy gaps of both materials of 2.3 eV [37,38] stay constant in the mixture. This seems to be a reasonable hypothesis, as there is no indication for charge transfer between both materials in the ground state that would lead to new features in the electronic structure. Postulating that this model is correct, one can derive the injection barriers for both electrons and holes from the shown energy level diagram. The obtained values are shown in fig. 10a. First, one notices that the injection barrier for holes into CuPc, i.e. the difference between the HOMO of CuPc and the Fermi level of Au (which is the reference level at binding energy zero) is larger than the respective injection barrier for electrons into C<sub>60</sub>. This is in excellent agreement with the output characteristics discussed before (see fig. 2). Furthermore, both injection barriers are predicted to decrease from neat materials towards blends. This feature will be investigated separately in the next section when we analyse contact resistances in OFETs.

Before going to this, we would like to point out another interesting conclusion from the energy level diagram of these ambipolar blends which is related to photovoltaic cells based on CuPc and C<sub>60</sub> as a donor-acceptor system. Upon photoexcitation excitons generated in either of the two materials (within the reach of the respective exciton diffusion length) will be dissociated at the organic-organic interface leading to electrons in the LUMO of C<sub>60</sub> and holes in the HOMO of CuPc. This charge separation leads to a gradient of the chemical potential at the interface that drives the photocurrent through the cell [60]. Thus the magnitude of the HOMO-LUMO offset between both materials will be related to the driving force, for which the opencircuit voltage can serve as an easily accessible experimental quantity. The obtained electronic structure therefore allows the conclusion that the HOMO-LUMO offset in blends is significantly smaller than at the heterojunction between neat layers of CuPc and C<sub>60</sub> [53]. Preliminary measurements have indeed shown that the open-circuit voltage in a bulk-hetero junction organic photovoltaic cell (1:1 mixture) is about 0.2 V smaller than in a cell comprising a planar interface between CuPc and C<sub>60</sub> [61].







**Figure 10** (a) Injection barrier determined from UPS (compare fig. 9). (b) Mobility (solid line) and contact resistance (dashed line) as determined from transfer characteristics in the linear regime for  $|V_{\rm G}-V_{\rm T}|$ =33 V. (c) Relation between mobility and contact resistance for different  $|V_{\rm G}-V_{\rm T}|>|V_{\rm D}|$  and different mixing ratios (0, 25, 50, 75 and 100 % C<sub>60</sub>). The straight lines are linear fits related to the vacuum level shift in part (a) and to guide the eyes in the parts (b) and (c).

**8 Charge carrier injection** Information on charge carrier injection was obtained from analysing contact resistances in OFETs. In contrast to section 5, we now use trans-

fer curves in the linear range. Following a procedure suggested by Horowitz [62] the drain voltage in the Shockley equation is replaced by the drain voltage corrected by the contact resistance  $(V_{\rm D} \rightarrow V_{\rm D} - I_{\rm D} \cdot R_{\rm C})$ . As a result the drain current is given by

$$I_{\rm D} = \frac{(W/L)C_{\rm Ox}\mu(V_{\rm G} - V_{\rm T})V_{\rm D}}{1 + (W/L)C_{\rm Ox}\mu R_{\rm C}(V_{\rm G} - V_{\rm T})}.$$
 (3)

Using the channel conductance  $g_{\rm d}=\partial I_{\rm D}/\partial V_{\rm D}$  and the transconductance  $g_{\rm m}=\partial I_{\rm D}/\partial V_{\rm G}$  the mobility  $\mu$  and the contact resistance  $R_{\rm C}$  were calculated from

$$\sqrt{\mu}(V_{\rm G} - V_{\rm T}) = \frac{g_{\rm d}}{\sqrt{g_{\rm m}}} \cdot \sqrt{\frac{LV_{\rm D}}{WC_{\rm Ox}}}$$
(4)

and

$$R_{\rm C} = \frac{1}{g_{\rm d}} - \frac{L}{W\mu C_{\rm Ox}(V_{\rm G} - V_{\rm T})}.$$
 (5)

In this calculation the dependence of  $\mu$  and  $R_{\rm C}$  on  $V_{\rm G}$  is neglected for the derivatives. To minimize the error of this simplification the mobilities and the contact resistances are plotted in fig. 10b for  $V_{\rm D}=10$  V at a constant  $|V_{\rm G}-V_{\rm T}|=33$  V (using O-plasma treatment and  $100^{\circ}{\rm C}$  substrate temperature). Once again, one observes decreasing mobilities with decreasing concentration of the transport material like in the saturation regime shown in fig. 4 and the contact resistance increases upon dilution. This behaviour is in contrast to the injection barrier shown in fig. 10a, which decreases with decreasing amount of the respective transport material, and can be taken as a clear indication that an additional mechanism has to be taken into account in the injection process.

First, there is a pure geometrical effect, meaning that the effective contact area will decrease if less molecules of one type are present in the mixture. However, this would only lead to a linear change of both mobility and contact resistance with the mixing ratio that can not account for the observed variation over several orders of magnitude. Thus as a second possibility, we consider the case that the injection process is influenced by the same reduction of the intermolecular hopping distance as discussed before for the mobility. Therefore, we plot in fig. 10c the contact resistance vs. mobility for all presented mixing ratios and for different charge carrier densities (related to different values of  $|V_{\rm G} - V_{\rm T}|$ ). A reciprocal relation  $R_{\rm C} \sim \mu^{-1}$  is observed indicating that in the presented system the mobility limits the injection of charge carriers. This behaviour can be explained by diffusion limited injection [32] following the equation

$$j_{\rm inj} \sim \mu \cdot \exp\left[-\frac{\Phi_{\rm B}}{kT}\right].$$
 (6)

This mechanism was already identified in organic photoconductors [63] varying the mobility by mixing semiconducting and insulating molecules and in unipolar OFETs

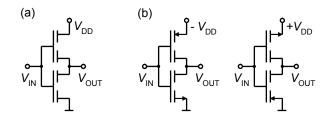
[64] varying the mobility by the charge carrier concentration. Thus our investigations show that mixing of organic semiconductors has important consequences for both charge carrier injection and transport which will be relevant in various kinds of devices, including not only OFETs, but also OPV cells and OLEDs. (Actually, it was already demonstrated in OLEDs that grading interfaces can enhance device efficiency by reducing energy barriers at organic/organic interfaces and probably also enhancing recombination rates by slowing down carriers [65].)

**9** Ambipolar and complementary Inverter As already mentioned, there was the suggestion of using ambipolar FETs to realize complementary-like organic integrated circuits [3,17,10,66]. Here we investigate ambipolar inverters consisting of mixed-layer ambipolar FETs and compare their characteristics to a complementary inverter made of discrete p- and n-channel transistors from neat materials

Ambipolar inverters or complementary-like inverters are based on two ambipolar transistors (fig. 11a). These inverters are working with positive and negative driving voltage thereby the sign of the driving voltage determines which of the two transistors works as n- and p-transistor (fig. 11b). Complementary inverters in contrast to that are based on unipolar n- and p-transistors with a defined power supply either as shown in fig. 11b or fig. 11c. However, to realize such a circuit patterning of the organic semiconductor or locally different surface functionalisation are required to achieve spatially separated p- and n-conducting regions which is not necessary in the case of ambipolar inverters. In order to evaluate the performance of these different concepts we have fabricated both ambipolar and complementary inverters and compared their output characteristics both by experimental studies und simulations.

Figure 12a, b show the characteristics of ambipolar inverters using layers with mixing ratios of 3:1 and 1:3. The upper part presents the transfer characteristics of the inverters (output voltage vs. input voltage) and the lower part the corresponding current supplied by  $V_{\rm DD}$ = $\pm 90~V$  which directly gives the dissipated current in the circuit.

A characteristic feature of ambipolar inverters is their operation in the first as well as in the third quadrant of the



**Figure 11** (a) Electrical circuit for an ambipolar inverter. (b) The two operation regimes (positive and negative supply voltage) for ambipolar and complementary inverters.

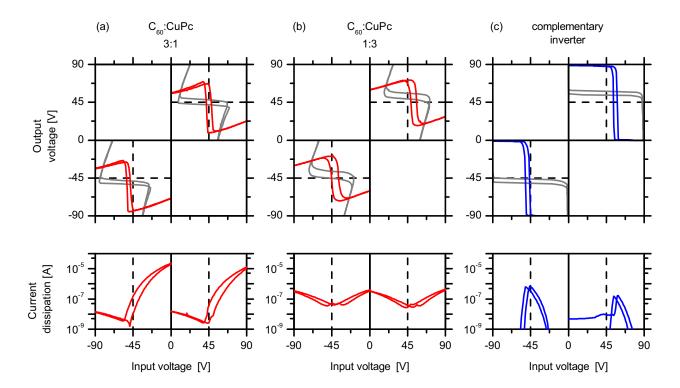


Figure 12 Characteristics of ambipolar inverters with mixing ratios of 3:1 (a) and 1:3 (b) and a complementary inverter (c) consisting of a neat  $C_{60}$  and a neat CuPc transistor. The driving voltage is  $V_{\rm DD}=\pm90$  V. Transfer characteristics (top) and current dissipation (bottom) are shown. The substrates were  $O_2$ -plasma treated and the films evaporated at 375 K substrate temperature. The grey line are shown to explain the noise margin (see text). (Figure adopted from Ref. [27].)

output-vs.-input diagram, depending on the sign of the supply voltage only. Ideally an inverter should have a sharp transition from the low to the high state at half of the driving voltage and the dissipated current should be negligible small except for a narrow range around the transition voltage. Both inverters, based on two ambipolar transistors, show this transition at about half of the supply voltage  $(V_{\rm DD}/2=\pm45~{\rm V})$  and reach high gain (about 13 for the 1:3 mixture and about 18 for the 3:1 mixture) which is defined as the steepness of the characteristics at the transitions between the high and the low states. However, they do not reach zero in the low state and the driving voltage in the high state. Also the voltages at the high and the low state are not constant.

The noise margin is an indicator for the tolerance of cascaded inverter stages. To demonstrate this, figure 12 contains also the inverter characteristics mirrored at the bisecting line, which can be considered as the output of a following inverter. The noise margin is then defined as the largest possible square between these two curves. In this case the noise margin amounts to about 14 V for the 1:3 mixture and about 19 V for the 3:1 mixture.

Significant differences between the two ambipolar inverters are observed in the dissipated current. Whereas for the inverter with a 1:3 mixing ratio the power dissipation

is symmetric around  $\pm 45$  V, the device with a 3:1 mixture shows an asymmetry of about three orders of magnitude. Moreover, the dissipated current is as high as  $10^{-5}$  A, which is one-and-a-half orders of magnitude larger than in the previous case. Thus, it is remarkable that a huge asymmetry in electron and hole mobilities of more than three orders of magnitude, as observed for the 3:1 mixture (see fig. 4), has drastic consequences for the power dissipation of the inverter, although it does not lead to a significant asymmetry in the transition voltage.

For comparison we have also fabricated a complementary inverter by connecting a p-channel transistor (neat CuPc) and an n-channel transistor (neat  $C_{60}$ ) together, its characteristics being shown in fig. 12c. In order to make it operate in the first quadrant it is necessary to connect the p-channel transistor to  $+V_{\rm DD}$  and the n-channel transistor to ground and vice versa the n-channel transistor to  $-V_{\rm DD}$  and the p-channel transistor to ground in order make it operate in the third quadrant as seen in fig. 11. These inverters also show slightly asymmetric transitions with respect to  $\pm V_{\rm DD}/2$  due to the unbalanced electron and hole mobilities in neat CuPc and  $C_{60}$ , but they reach the ground potential in the low state and the supply voltage in the high state. The gain is about 38 and the noise margin is about 29 V for a positive supply voltage, respectively 34 and 32 V for

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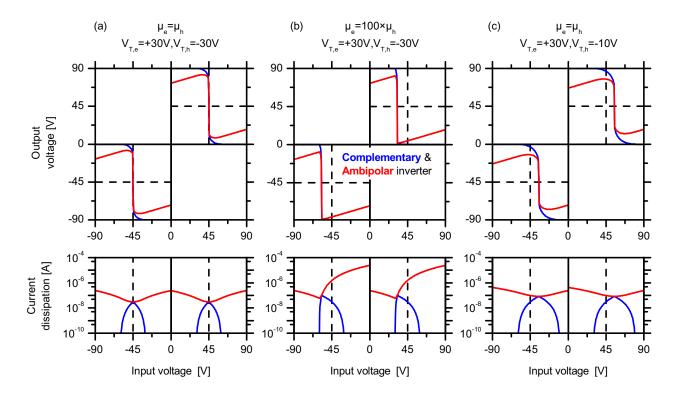


Figure 13 Simulations of ambipolar and complementary inverter transfer characteristics and current dissipation with (a) symmetric mobility and threshold voltage for p- and n-channel in comparison to (b) asymmetric mobilities and (c) asymmetric threshold voltages.

a negative supply voltage. So these values are about twice as high as those of the ambipolar inverters. A characteristic difference to the ambipolar inverter type is the current dissipation being high only in the vicinity of the transition. This is because at any time one of the two transistors is being switched off in each of the logic states whereas an ambipolar transistor always shows a non-negligible current.

For a better understanding of inverter characteristics we performed numerical simulations based on the analytical model of Schmechel et al. [13] for both ambipolar and complementary inverters. The output voltage as well as the current dissipation was calculated to demonstrate the differences between ambipolar and complementary inverters and the influence of device parameters like mobility and threshold voltage.

Figure 13 shows simulated transfer characteristics of ambipolar and complementary inverters. In the left picture balanced mobilities ( $\mu_{\rm e}$ = $\mu_{\rm h}$ ) and symmetric threshold voltages ( $V_{\rm T,e}$ = $-V_{\rm T,h}$ =30 V) were used for the simulation. The picture in the middle shows the characteristics for symmetric threshold voltages ( $V_{\rm T,e}$ = $-V_{\rm T,h}$ =30 V) but different mobilities ( $\mu_{\rm e}$ =100 $\mu_{\rm h}$ ). Whereas, in the right picture balanced mobilities ( $\mu_{\rm e}$ = $\mu_{\rm h}$ ) and different threshold voltages ( $V_{\rm T,e}$ =+30 V,  $V_{\rm T,h}$ =-10 V) were used. In all cases, as observed before in the measurements, the output voltage of the complementary inverter reaches the driving and the ground voltage in the high and the low state, respectively,

whereas the output voltage of the ambipolar inverter does not [10]. Thus the noise margin of the ambipolar inverters are lower than for the complementary inverters. Nevertheless the gain for both types of inverters is comparably high. As expected the current dissipation in the complementary inverter has a maximum at the transition between the logic levels, whereas the ambipolar inverter has its minimum at this point.

A closer look at the simulations in fig. 13a, which are based on symmetric mobilities and threshold voltages, shows that the transition between the logic states is at the half of the driving voltage for both the ambipolar and the complementary inverter. An asymmetry in carrier mobilities (fig. 13b) and/or in threshold voltages (fig. 13c) leads to a shift of the transition voltage in both cases. Nevertheless, the transition voltages of the measured inverters (fig. 12a, c) are still more or less symmetric although the mobilities are largely different. The reason is that in both cases the shift of the transition voltage due to the higher mobility in the n-channel is compensated by a lower threshold voltage in the p-channel. One can further see that different mobilities have no influence on the gain, whereas different, especially lower, threshold voltages decrease both the gain and the noise margin. Experimentally, we have a decrease of the threshold voltage in the p-channel by diluting CuPc with  $C_{60}$  (fig. 4) and accordingly the gain in the measured ambipolar inverters is lower than in the complementary inverter. Finally, it is evident that the current dissipation of an ambipolar inverter is increasing drastically in the case of asymmetric mobilities. Altogether, complementary inverters are clearly superior to their ambipolar counterparts, but in both cases equal mobilities and symmetric threshold voltages are required to achieve optimal inverter characteristics.

10 Summary Mixtures of hole conducting CuPc and electron conducting  $C_{60}$  show ambipolar transport for all investigated mixing ratios. However, the mobilities of electrons and holes are strongly dependent on the composition indicating that percolation is a critical issue. Unlike in polymer/fullerene blends, there is no evidence for strong structural interactions, the materials rather simply dilute each other. This is manifested also by the electronic structure of the blends, which does not show any significant evidence for charge transfer in the ground state.

Due to the higher electron mobility in neat  $C_{60}$  (as compared to the hole mobility in neat CuPc), an excess of CuPc (75%) is required to achieve balanced mobilities. But even with equal electron and hole mobilities an ambipolar inverter is inferior to a complementary one with discrete p- and n-channel transistors. Thus realizing true complementary logic circuits will require devising efficient patterning methods, e.g. by locally different functionalisation of the gate insulator.

Furthermore, our investigations of the electronic structure allow the conclusion that the HOMO-LUMO offset is significantly smaller in blends as compared to planar interfaces between both materials. Together with the lowering of the charge carrier mobility this reduction of the "built-in field" could have important consequences for photovoltaic cells based on these molecular materials. Bulk heterojunction devices with homogeneously mixed donor/acceptor layers will not necessarily be the optimal film morphology. The challenge will be to grow suitable blend morphologies with interdigitated donor/acceptor phases that simultaneously have large interfacial area and high exciton diffusion and charge carrier drift length for efficient charge carrier generation and extraction.

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## References

- [1] W. Warta and N. Karl, Phys. Rev. B 32, 1172–1182 (1985).
- [2] C. D. Dimitrakopoulos and P. R. L. Malenfant, Adv. Mater. 14, 99–117 (2002).
- [3] E. J. Meijer, D. M. De Leeuw, S. Setayesh, E. Van Veenendaal, B. H. Huisman, P. W. M. Blom, J. C. Hummelen, U. Scherf, and T. M. Klapwijk, Nature Mater. **2**, 678–682 (2003).

[4] C.J. Brabec, V. Dyakonov, J. Parisi, and N. S. Sariciftci, Organic Photovoltaics (Springer-Verlag, 2003).

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- [5] G. W. Neudeck and A. K. Malhotra, J. Appl. Phys. 46, 239– 247 (1975).
- [6] J. Locklin, K. Shinbo, K. Onishi, F. Kaneko, Z. N. Bao, and R. C. Advincula, Chem. Mater. 15, 1404–1412 (2003).
- [7] J. G. Xue and S. R. Forrest, Phys. Rev. B **69**, 245322 (2004).
- [8] J. Wang, H.B. Wang, X.J. Yan, H.C. Huang, and D.H. Yan, Appl. Phys. Lett. 87, 093507 (2005).
- [9] R. B. Ye, M. Baba, Y. Oishi, K. Mori, and K. Suzuki, Appl. Phys. Lett. 86, 253505 (2005).
- [10] Y. Inoue, Y. Sakamoto, T. Suzuki, M. Kobayashi, Y. Gao, and S. Tokito, Jpn. J. Appl. Phys. 1 44, 3663–3668 (2005).
- [11] M. A. Loi, C. Rost-Bietsch, M. Murgia, S. Karg, W. Rieß, and M. Muccini, Adv. Func. Mater. 16, 41–47 (2006).
- [12] T. Yasuda, T. Goto, K. Fujita, and T. Tsutsui, Appl. Phys. Lett. 85(11), 2098–2100 (2004).
- [13] R. Schmechel, M. Ahles, and H. von Seggern, J. Appl. Phys. 98, 084511 (2005).
- [14] L. L. Chua, J. Zaumseil, J. F. Chang, E. C. W. Ou, P. K. H. Ho, H. Sirringhaus, and R. H. Friend, Nature 434, 194–199 (2005).
- [15] M. Ahles, R. Schmechel, and H. von Seggern, Appl. Phys. Lett. 85, 4499–4501 (2004).
- [16] E. C. P. Smits, T. D. Anthopoulos, S. Setayesh, E. van Veenendaal, R. Coehoorn, P. W. M. Blom, B. de Boer, and D. M. de Leeuw, Phys. Rev. B 73, 205316 (2006).
- [17] T. D. Anthopoulos, S. Setayesh, E. Smith, M. Cölle, E. Cantatore, B. de Boer, P. W. M. Blom, and D. M. de Leeuw, Adv. Mater. 18, 1900–1904 (2006).
- [18] J. Rostalski and D. Meissner, Sol. Energ. Mat. Sol. C. 61, 87–95 (2000).
- [19] T. Stübinger and W. Brütting, J. Appl. Phys. 90(7), 3632–3641 (2001).
- [20] P. Sullivan, S. Heutz, S. M. Schultes, and T. S. Jones, Appl. Phys. Lett. 84(7), 1210–1212 (2004).
- [21] J. G. Xue, B. P. Rand, S. Uchida, and S. R. Forrest, J. Appl. Phys. 98, 124903 (2005).
- [22] G. Paasch, T. Lindner, C. Rost-Bietsch, S. Karg, W. Rieß, and S. Scheinert, J. Appl. Phys. **98**, 084505 (2005).
- [23] A. Hepp, H. Heil, W. Weise, M. Ahles, R. Schmechel, and H. von Seggern, Phys. Rev. Lett. 91, 157406 (2003).
- [24] C. Rost, S. Karg, W. Rieß, M. A. Loi, M. Murgia, and M. Muccini, Appl. Phys. Lett. 85, 1613–1615 (2004).
- [25] J. Zaumseil, R.H. Friend, and H. Sirringhaus, Nature Mater. 5, 69–74 (2006).
- [26] S. Grecu, M. Roggenbuck, A. Opitz, and W. Brütting, Org. Electron. **7**, 276–286 (2006).
- [27] A. Opitz, M. Bronner, and W. Brütting, J. Appl. Phys. 101, 063709 (2007).
- [28] E. J. Meijer, C. Detcheverry, P. J. Baesjou, E. van Veenendaal, D. M. de Leeuw, and T. M. Klapwijk, J. Appl. Phys. 93, 4831–4835 (2003).
- [29] N. Marjanovic, T.B. Singh, G. Dennler, S. Gunes, H. Neugebauer, N.S. Sariciftci, R. Schwödiauer, and S. Bauer, Org. Electron. 7, 188–194 (2006).
- [30] R. Tecklenburg, G. Paasch, and S. Scheinert, Adv. Mater. Opt. Electron. 8(6), 285–294 (1998).

- [31] T. Lindner, G. Paasch, and S. Scheinert, J. Appl. Phys. 98, 114505 (2005).
- [32] S. Sze, Physics of Semiconductor Devices (Wiley, New York, 1982).
- [33] M. Knupfer and H. Peisert, phys. stat. sol. (a) 201, 1055– 1074 (2004).
- [34] O. V. Molodtsova, T. Schwieger, and M. Knupfer, Appl. Surf. Sci. 252, 143–147 (2005).
- [35] S. C. Veenstra and H. T. Jonkman, J. Poly. Sci. B 41, 2549– 2560 (2003).
- [36] O. V. Molodtsova and M. Knupfer, J. Appl. Phys. 99, 053704 (2006).
- [37] I. Hill, A. Kahn, Z. Soos, and R. Pascal, Chem. Phys. Lett. 327, 181–188 (2000).
- [38] R. W. Lof, M. A. Vanveenendaal, B. Koopmans, H. T. Jonkman, and G. A. Sawatzky, Phys. Rev. Lett. 68, 3924– 3927 (1992).
- [39] Y. Nobuhide, N. Makoto, H. Nobukazu, N. Kazumasa, W. Masaru, and K. Jiro, Appl. Phys. Lett. 85(20), 4663– 4665 (2004).
- [40] T. Lindner, G. Paasch, and S. Scheinert, J. Mater. Res. **19**(7), 2014–2027 (2004).
- [41] S. Cherian, C. Donley, D. Mathine, L. LaRussa, W. Xia, and N. Armstrong, J. Appl. Phys. 96, 5638–5643 (2004).
- [42] P. M. Borsenberger and D. S. Weiss, Organic Photoreceptors for Imaging Systems (Marcel Dekker Ltd, New York, 1993).
- [43] C. K. Song, B. W. Koo, S. B. Lee, and D. H. Kim, Jpn. J. Appl. Phys. 1 41, 2730–2734 (2002).
- [44] S. M. Tuladhar, D. Poplavskyy, S. A. Choulis, J. R. Durrant, D. D. C. Bradley, and J. Nelson, Adv. Func. Mater. 15, 1171–1182 (2005).
- [45] V. D. Mihailetchi, L. J. A. Koster, P. W. M. Blom, C. Melzer, B. de Boer, J. K. J. van Duren, and R. A. J. Janssen, Adv. Func. Mater. 15, 795–801 (2005).
- [46] B. P. Rand, J. G. Xue, S. Uchida, and S. R. Forrest, J. Appl. Phys. 98, 124902 (2005).
- [47] F. Dinelli, R. Capelli, M. A. Loi, M. Murgia, M. Muccini, A. Facchetti, and T. J. Marks, Adv. Mater. 18, 1416 (2006).
- [48] G. Horowitz, R. Hajlaoui, and P. Delannoy, J. Phys. III France 5, 355–371 (1995).
- [49] G. Paasch, P.H. Nguyen, and S.L. Drechsler, Synthetic Metals 97(3), 255–265 (1998).
- [50] F. Dinelli, M. Murgia, P. Levy, M. Cavallini, F. Biscarini, and D. M. de Leeuw, Phys. Rev. Lett. 92, 116802 (2004).
- [51] L. Lozzi, V. Granato, S. Picozzi, M. Simeoni, S. La Rosa, B. Delly, and S. Santucci, J. Vac. Sci. & Technol. A 24, 1668–1675 (2006).
- [52] D. Faiman, S. Goren, E. A. Katz, M. Koltun, N. Melnik, A. Shames, and S. Shtutina, Thin Solid Films 295, 283– 286 (1997).
- [53] A. Opitz, M. Bronner, W. Brütting, M. Himmerlich, J. A. Schaefer, and S. Krischok, Appl. Phys. Lett. 90, 212112 (2007).
- [54] S. M. Schultes, P. Sullivan, S. Heutz, B. M. Sanderson, and T. S. Jones, Mat. Sci. Eng. C - Biomim. 25, 858–865 (2005).
- [55] M. Stöhr, T. Wagner, M. Gabriel, B. Weyers, and R. Möller, Adv. Func. Mater. 11, 175–178 (2001).

- [56] T. Stübinger and W. Brütting, SPIE Proc. 4465, 102–112 (2002).
- [57] S. Rentenberger, A. Vollmer, E. Zojer, R. Schennach, and N. Koch, J. Appl. Phys. **100**, 053701 (2006).
- [58] T. R. Ohno, Y. Chen, S. E. Harvey, G. H. Kroll, J. H. Weaver, R. E. Haufler, and R. E. Smalley, Phys. Rev. B 44, 13747–13755 (1991).
- [59] G. Koller, B. Winter, M. Oehzelt, J. Ivanco, F.P. Netzer, and M. G. Ramsey, Org. Electron. 8, 63–68 (2007).
- [60] B. A. Gregg, MRS Bullettin 30, 20-22 (2005).
- [61] W. Brütting, M. Bronner, M. Götzenbrugger, and A. Opitz, Macromol. Symp. (2007), accepted.
- [62] G. Horowitz, R. Hajlaoui, D. Fichou, and A. El Kassmi, J. Appl. Phys. 85, 3202–3206 (1999).
- [63] Y. L. Shen, M. W. Klein, D. B. Jacobs, J. C. Scott, and G. G. Malliaras, Phys. Rev. Lett. 86, 3867–3870 (2001).
- [64] B. H. Hamadani and D. Natelson, Appl. Phys. Lett. 84, 443–445 (2004).
- [65] H. Riel, S. Barth, T. Beierlein, W. Brütting, S. Karg, P. Müller, and W. Rieß, SPIE Proc. 4105, 167–174 (2001).
- [66] G. W. Neudeck, K. Y. Chung, and H. F. Bare, IEEE Trans. Electron. Dev. 34, 866–871 (1987).